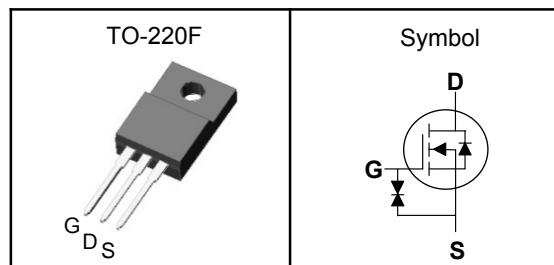


## 800V Super Junction Power MOSFET

### Features

- Low drain-source on-resistance:  $R_{DS(ON)}=0.33\Omega$  (typ)
- Easy to control gate switching
- Enhancement mode:  $V_{th} = 2.0$  to  $4.0V$
- 100% avalanche tested
- Built-in ESD Diode
- RoHS compliant

### Pin Description



### Applications

- Power Management in Desktop Computer
- DC/DC Converters

$V_{DSS}$	800	V
$R_{DS(ON)-Typ}$	330	$m\Omega$
$I_D$	13	A

### Absolute Maximum Ratings ( $T_J=25^\circ C$ , Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	800	V
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
$T_J$	Maximum Junction Temperature	-55 to 150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$E_{AS}$	Single Pulse Avalanche Energy <sup>③</sup>	320	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	39	A
$I_D$	Continuous Drain Current	$T_c=25^\circ C$	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ C$	W

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{JA}$	Thermal Resistance Junction-Ambient <sub>1</sub> (Max)	80	$^\circ C/W$
$R_{JC}$	Thermal Resistance Junction-Case <sub>1</sub>	3.87	$^\circ C/W$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature  $150^\circ C$ .

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

## 800V Super Junction Power MOSFET

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

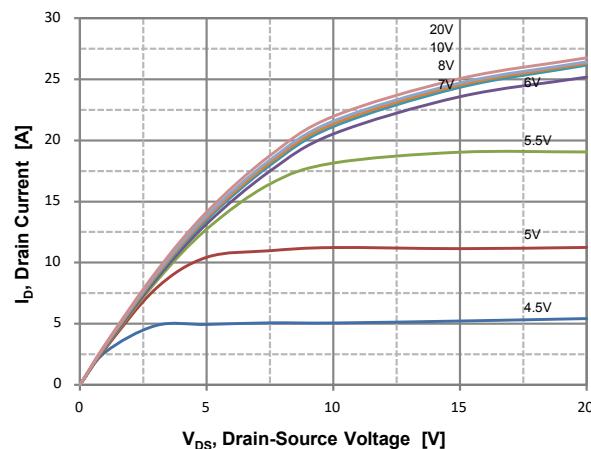
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_D=250\mu\text{A}$	800	---	---	V
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=800\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$ , $\text{I}_D=250\mu\text{A}$	2.0	---	4.0	V
$\text{I}_{\text{GSS}}$	Gate Leakage Current	$\text{V}_{\text{GS}}=\pm 30\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=3.4\text{A}$	---	330	380	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>⑤</sup></b>						
$\text{C}_{\text{iss}}$	Input Capacitance	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{V}_{\text{DS}}=500\text{V}$ , Freq.=1MHz	---	1230	---	pF
$\text{C}_{\text{oss}}$	Output Capacitance		---	26	---	
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance		---	3.3	---	
$\text{T}_{\text{d(on)}}$	Turn-on Delay Time	$\text{V}_{\text{DD}}=400\text{V}$ , $\text{R}_G=25\Omega$ , $\text{I}_D=6.2\text{A}$	---	29	---	nS
$\text{T}_r$	Turn-on Rise Time		---	20	---	
$\text{T}_{\text{d(off)}}$	Turn-off Delay Time		---	135	---	
$\text{T}_f$	Turn-off Fall Time		---	17	---	
$\text{Q}_g$	Total Gate Charge	$\text{V}_{\text{DD}}=640\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=6.2\text{A}$	---	29	---	nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge		---	5.2	---	
$\text{Q}_{\text{gd}}$	Gate-Drain Charge		---	8.8	---	
<b>Source-Drain Characteristics (<math>T_J=25^\circ\text{C}</math>)</b>						
$\text{V}_{\text{SD}}$	Diode Forward Voltage <sub>2</sub>	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_s=6.2\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1.3	V
$\text{t}_{\text{rr}}$	Reverse Recovery Time	$\text{V}_R=400\text{V}$ , $\text{I}_s=6.2\text{A}$ , $d\text{i}/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	360	---	nS
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge		---	3.8	---	nC

Note ④ : Pulse test (pulse width $\leq 300\text{us}$ , duty cycle $\leq 2\%$ ).

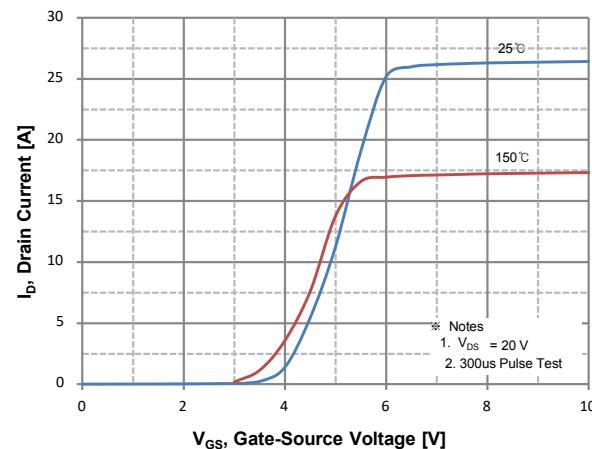
Note ⑤ : Guaranteed by design, not subject to production testing.

## 800V Super Junction Power MOSFET

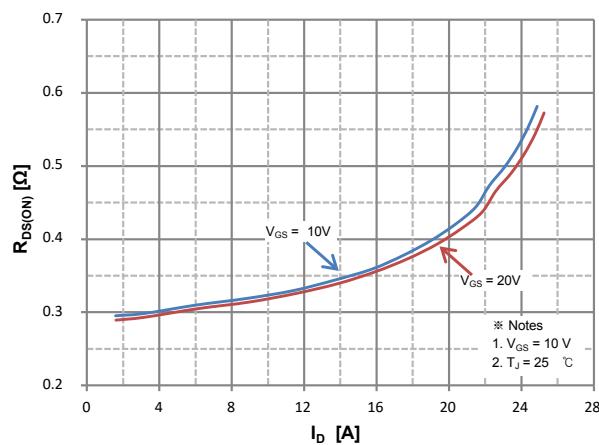
### On Region Characteristics



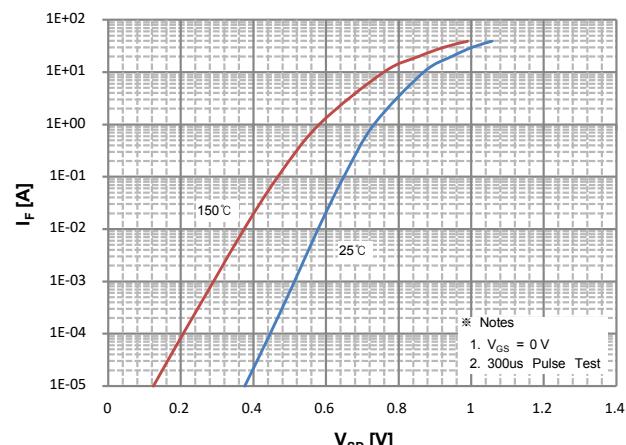
**Figure 1. On Region Characteristics**



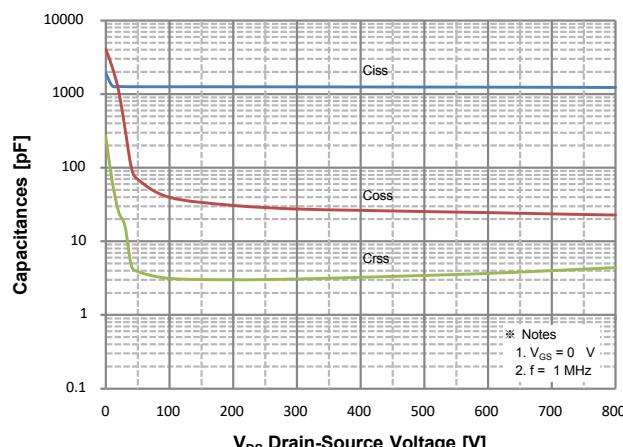
**Figure 2. Transfer Characteristics**



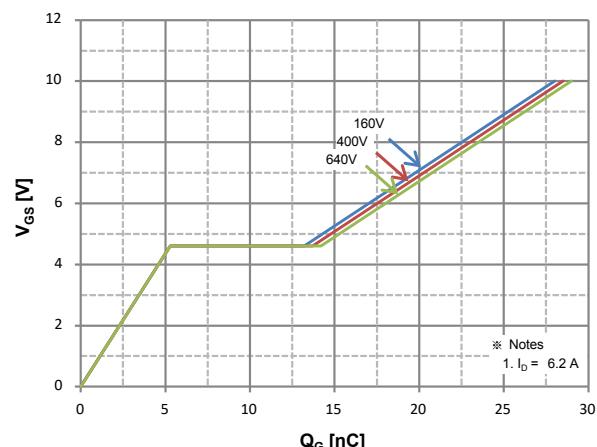
**Figure 3. On Resistance Variation vs Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**

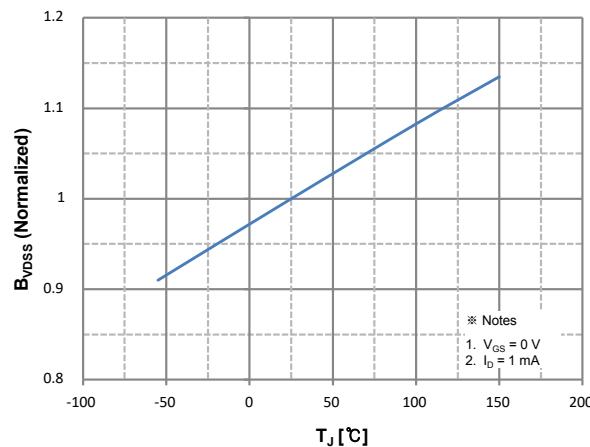


**Figure 5. Capacitance Characteristics**

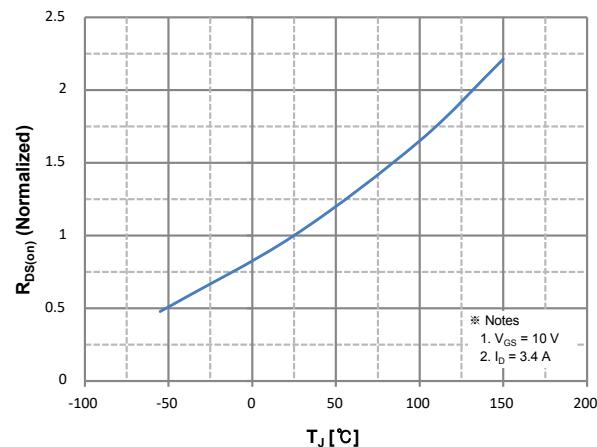


**Figure 6. Gate Charge Characteristics**

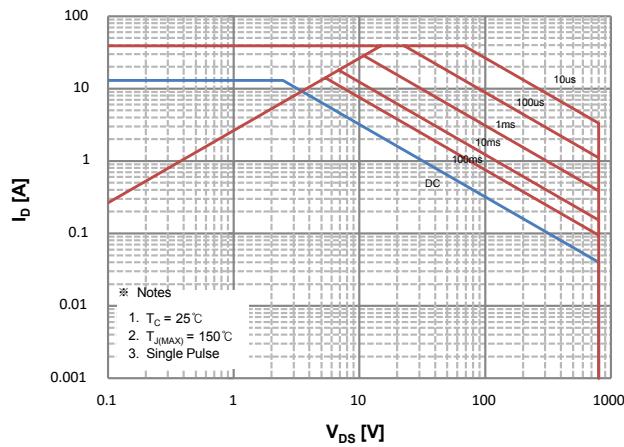
## 800V Super Junction Power MOSFET



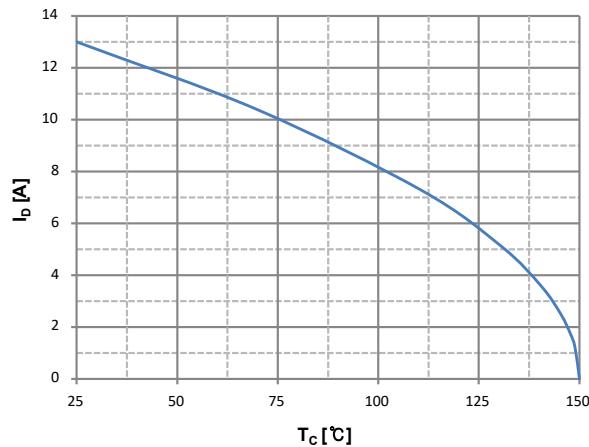
**Figure 7. Breakdown Voltage Variation  
vs. Temperature**



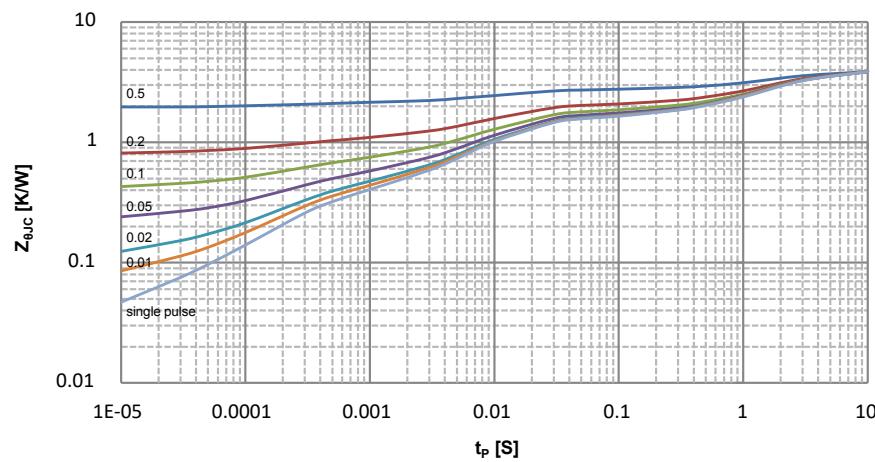
**Figure 8. On-Resistance Variation  
vs. Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current  
vs. Case Temperature**



**Figure 11. Transient Thermal Response Curve**

## 800V Super Junction Power MOSFET

## TO-220F Package Outline Data

